form PTO-1595 (Rev. 07/05) OMB No. 0651-0027 (exp. 6/30/2008) U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office Atty. Docket No.; <u>T&A-140</u>

RECORDATION FORM COVER SHEET PATENTS ONLY	
1. Name of conveying parties	2. Name and address of receiving party
1) Shiro YAMASHITA	
2) Abe YOICHI 3) Kenichi YAMAMOTO	Name: <u>Renesas Technology Corp.</u>
4) Ryosuke KIMOTO	Internal Address:
5) Hiroshi KAWAKUBO	
Additional name(s) of conveying party(ies) attached Yes No	
3. Nature of conveyance/Execution Date(s): Execution Date(s) <u>1) 7/26/05; 2) 7/29/05; 3, 5) 8/4/05;</u>	Street Address: 4-1, Marunouchi 2-chome
4) 8/8/05	
Assignment Merger	City: Chivoda-ku
Security Agreement Change of Name	State: <u>Tokyo</u>
Joint Research Agreement	Country: <u>Japan</u> Zip:
Government Interest Assignment	Additional Name(s) & Addresses attached? 🛄 Yes 🖾 No
4. Application or patent number(s):	document is being filed together with a new application.
A. Patent Application No.(s)	B. Patent No.(s)
11/146,044	
Additional numbers attached? 🔛 Yes 🔀 No	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:one
Name: <u>Daniel J. Stanger</u>	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Firm: <u>Mattingly, Stanger, Malur & Brundidge, P.C.</u>	Authorized to be charged by credit card
Street Address: <u>1800 Diagonal Road, Suite 370</u>	Authorized to be charged to deposit account
City: <u>Alexandria</u>	
State: <u>Virginia</u> Zip: <u>22314</u>	None required (government interest not affecting title)
Phone Number: <u>703 684-1120</u>	8. Payment Information
Fax Number: <u>703 684-1157</u>	a. Credit Card Last 4 Numbers <u>1009</u> Expiration Date <u>8/2009</u>
Email Address:	b. Deposit Account Number <u>50-1417</u>
	Authorized User Name Daniel J. Stanger
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A HAL	
9. Signature:	August 2, 2006
\$ignature	Date
Daniel J. <u>Stanger, Reg. No. 32,846</u>	Total number of pages including cover
Name of Person Signing	Sheet, attachments, and documents: 3
Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450	

PATENT REEL: 018053 FRAME: 0163

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp. a corporation organized under the laws of Japan,

located at 4-1.Marunouchi 2-chome.Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp.

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said. Renesas Technology Corp.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

INVENTOR(\$) Date Signed (発明者フルネームサイン) (署名日) 26, Kenichi Yanamoto Kimoto IDSUKE. Hiroshi Kawakubo - S/4/05 6) _____ 7) 8) _____ 9) 10)

RECORDED: 08/02/2006

PATENT REEL: 018053 FRAME: 0164